## FAN5601

## Regulated Step-Down Charge Pump DC/DC Converter

## Features

- > 85\% Peak Efficiency
- Low EMI
- Low Ripple
- Output Voltage $1.3 \mathrm{~V} / 1.8 \mathrm{~V}$
- Input Voltage Range: 2.2 V to 5.5 V
- Output Current: Up to 250 mA
- $\pm 2.5 \%$ Output Voltage Accuracy
- $30 \mu \mathrm{~A}$ Operating Current
- $\mathrm{I}_{\mathrm{CC}}<1 \mu \mathrm{~A}$ in Shutdown Mode
- 2 MHz Operating Frequency
- Shutdown Isolates Output from Input
- Soft-Start Limits Inrush Current
- Short Circuit and Over Temperature Protection
- Minimum External Component Count
- 6-Lead 3x3mm MLP Package


## Applications

- Cell Phones
- Handheld Computers
- Portable Electronic Equipment
- Core Supply to Next Generation Processors
- Low Voltage DC Bus
- Digital Cameras
- DSP Supplies


## Description

The FAN5601 is an advanced third generation switched capacitor step down DC/DC converter utilizing Fairchild's proprietary ScalarPump ${ }^{\text {TM }}$ technology. This innovative architecture utilizes scalar switch re-configuration and fractional switching techniques to produce low output ripple, low ESR spikes and improve efficiency over a wide load range.

The FAN5601 produces a fixed regulated output from 2.2 V to 5 V input voltage. Customized output voltages are available in 100 mV increments from 1 V to 1.8 V . Contact marketing for customized outputs.

In order to maximize efficiency, the FAN5601 achieves regulation by skipping pulses. Depending upon load current, the size of the switches is scaled dynamically, consequently, current spikes and EMI are minimized. An internal soft start circuitry prevents excessive current drawn from the supply. The device is internally protected against short circuit and over temperature conditions.

The FAN5601 is available in 6-lead 3x3mm MLP.

ScalarPump ${ }^{\text {TM }}$ is a registered trademark of Fairchild Semiconductor Corporation.

## Typical Application



## Pin Assignment



## 6-Lead 3x3mm MLP

## Pin Description

| Pin No. | Pin Name | Pin Function Description |
| :---: | :---: | :--- |
|  | 6-Lead 3x3mm MLP |  |
| 1 | C+ | Bucket Capacitor Negative Connection |
| 2 | C- | Enable Pin |
| 3 | ENABLE | No Connection |
| 4 | GND | No Connection |
| 5 | $\mathrm{~V}_{\text {OUT }}$ | Ground |
| 6 | $\mathrm{~V}_{\text {IN }}$ |  |

Absolute Maximum Ratings (Note1)

| Parameter | Min | Max | Unit |
| :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\text {IN }}, \mathrm{V}_{\text {OUT }}$, ENABLE to GND | -0.3 | 6.0 | V |
| $\mathrm{C}+$, C-, to GND | -0.3 | $\mathrm{~V}_{\text {IN }}+0.3$ | V |
| $\mathrm{~V}_{\text {OUT }}$ Short Circuit Duration |  | INDEFINITE |  |
| Lead Soldering Temperature (10 seconds) |  | 300 | ${ }^{\circ} \mathrm{C}$ |
| Operating Temperature Range | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |
| Junction Temperature |  | 150 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | -55 | 150 | ${ }^{\circ} \mathrm{C}$ |
| Electrostatic Discharge (ESD) Protection (Note2) | HBM | 4 |  |
|  | kV |  |  |

## Recommended Operating Conditions

| Parameter | Package | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Input Voltage |  | 2.2 |  | 5.5 | V |
| Output Current |  |  |  | 250 | mA |
| Operating Ambient Temperature |  | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |
| Thermal Resistance Junction to Tab | 6-lead 3x3mm MLP |  | 8 |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Thermal Resistance Junction to Ambient | 6-lead 3x3mm MLP (Note 3) |  | 90 |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## Notes:

1. Operation beyond the absolute maximum rating may cause permanent damage to device.
2. Using Mil Std. 883E, method 3015.7(Human Body Model) and EIA/JESD22C101-A (Charge Device Model).
3. One square inch, 10 bottom side GND plane connected to top side GND plane by field of via.

## Electrical Characteristics

$\mathrm{V}_{\mathrm{IN}}=2.2 \mathrm{~V}$ to 5.5 V , $\mathrm{I}_{\mathrm{OUT}}=1 \mathrm{~mA}, \mathrm{C}_{\mathrm{B}}=1 \mu \mathrm{~F}, \mathrm{C}_{\mathrm{IN}}=10 \mu \mathrm{~F}, \mathrm{C}_{\mathrm{OUT}}=10 \mu \mathrm{~F}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, typical values measured at $T_{A}=25^{\circ} \mathrm{C}$, unless otherwise noted.

| Parameter | Conditions | Min. | Typ. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Input Undervoltage Lockout |  | 1.9 | 2.0 | 2.17 | V |
| Output Voltage |  |  | Vnom |  | V |
| Output Voltage Accuracy | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\text {IN }}=3.3 \mathrm{~V}$ | -2 |  | +2 | \% |
|  | $\mathrm{V}_{\text {IN }}=3.3 \mathrm{~V}$ | -2.5 |  | +2.5 | \% |
| Output Voltage Temperature Coefficient | $\mathrm{V}_{\text {IN }}=3.3 \mathrm{~V}$ |  | 25 |  | ppm |
| Load Regulation |  |  | 0.133 |  | $\mathrm{mV} / \mathrm{mA}$ |
| Line Regulation | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 1.35 | 2 | $\mathrm{mV} / \mathrm{V}$ |
| No load Supply Current (Note 4) | $\begin{aligned} \mathrm{I}_{\mathrm{OUT}} & =0 \mathrm{~mA}, \\ \mathrm{~V}_{\mathrm{IN}} & =2.2 \mathrm{~V} \end{aligned}$ |  | 30 | 60 | $\mu \mathrm{A}$ |
| Shutdown Supply Current | $\begin{aligned} \text { ENABLE } & =\text { GND } . \\ V_{\text {OUT }} & =0 \end{aligned}$ |  | 0.1 | 1 | $\mu \mathrm{A}$ |
| Output Short-circuit Current (Note 5) | $\mathrm{V}_{\text {OUT }}=$ GND. |  | 25 |  | mA |
| Efficiency | $\begin{gathered} \mathrm{V}_{\text {IN }}=2.35 \times \mathrm{V}_{\text {OUT }} \\ \mathrm{I}_{\text {OUT }}=150 \mathrm{~mA} \end{gathered}$ |  | 85 |  | \% |
| $\mathrm{V}_{\mathrm{IN}}$ at Configuration Change | From 2:1 to 1:1 mode |  | $\begin{aligned} & 2.22 x \\ & \text { Vnom } \end{aligned}$ |  | V |
| Oscillator Frequency |  |  | 2.0 |  | MHz |
| Thermal Shutdown Threshold |  |  | 150 |  | ${ }^{\circ} \mathrm{C}$ |
| Thermal Shutdown Threshold Hysteresis |  |  | 15 |  | ${ }^{\circ} \mathrm{C}$ |
| ENABLE Logic Input High Voltage, $\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{V}_{\mathrm{IN}}=2.2 \mathrm{~V}$ to 5.5 V | 1.3 |  |  | V |
| ENABLE Logic Input Low Voltage, $\mathrm{V}_{\text {IL }}$ | $\mathrm{V}_{\mathrm{IN}}=2.2 \mathrm{~V}$ to 5.5 V |  |  | 0.4 | V |
| ENABLE Logic Input Current | ENABLE $=\mathrm{V}_{\text {IN }}$ or GND | -1 |  | 1 | $\mu \mathrm{A}$ |
| V ${ }_{\text {Out }}$ Turn On Time | $\begin{gathered} \mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=0 \mathrm{~mA}, \\ 10 \% \text { to } 90 \% \end{gathered}$ |  | 1 |  | mS |

## Notes:

4. No load supply current is measured when the oscillator is off.
5. The short circuit protection is designed to protect against pre-existing short circuit conditions, i.e. assembly shorts that exist prior to device power-up. The short circuit current limit is $25 \mathrm{~mA}_{\text {Average }}$. Short circuit currents in normal operation are inherently limited by the ON-resistance of internal device. Since this resistance is in the range of $1 \Omega$, in some cases thermal shutdown may occur. However, immediately following the first thermal shutdown event, the short circuit condition will be treated as preexisting, and the load current will reduce to $25 \mathrm{~mA}_{\text {Average }}$.

## Typical Performance Characteristics

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\text {IN }}=\mathrm{C}_{\text {OUT }}=10 \mu \mathrm{~F}, \mathrm{C}_{\mathrm{B}}=1 \mu \mathrm{~F}, \mathrm{~V}_{\text {OUT }}=1.3 \mathrm{~V}$, unless otherwise noted.




Output Voltage vs Ambient Temperature


## Typical Performance Characteristics (cont.)

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\text {IN }}=\mathrm{C}_{\text {OUT }}=10 \mu \mathrm{~F}, \mathrm{C}_{\mathrm{B}}=1 \mu \mathrm{~F}, \mathrm{~V}_{\text {OUT }}=1.3 \mathrm{~V}$, unless otherwise noted.





Output Ripple


Time ( $40 \mathrm{~ms} / \mathrm{div}$ )


Time (20ms/div)

## Typical Performance Characteristics (cont.)

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\text {IN }}=\mathrm{C}_{\text {OUT }}=10 \mu \mathrm{~F}, \mathrm{C}_{\mathrm{B}}=1 \mu \mathrm{~F}, \mathrm{~V}_{\text {OUT }}=1.3 \mathrm{~V}$, unless otherwise noted.


Time (20ms/div)


Time ( $100 \mu \mathrm{~s} / \mathrm{div}$ )



## Typical Performance Characteristics (cont.)

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{IN}}=\mathrm{C}_{\mathrm{OUT}}=10 \mu \mathrm{~F}, \mathrm{C}_{\mathrm{B}}=1 \mu \mathrm{~F}, \mathrm{~V}_{\mathrm{OUT}}=1.3 \mathrm{~V}$, unless otherwise noted.


Time (1 $\mu \mathrm{s} / \mathrm{div}$ )

## Typical Performance Characteristics (cont.)

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{IN}}=\mathrm{C}_{\mathrm{OUT}}=10 \mu \mathrm{~F}, \mathrm{C}_{\mathrm{B}}=1 \mu \mathrm{~F}, \mathrm{~V}_{\mathrm{OUT}}=1.3 \mathrm{~V}$, unless otherwise noted.




## Block Diagram



## Detailed Description

The FAN5601 switched capacitor DC/DC converter automatically configures switches to achieve a high efficiency and provides a regulated output voltage by means of pulse skipping, pulse frequency modulation (PFM). An internal soft start circuit prevents excessive inrush current drawn from the supply. Each switch is split into three segments. Based on the values of $\mathrm{V}_{\mathrm{IN}}, \mathrm{V}_{\text {OUT }}$ and $\mathrm{I}_{\text {OUT }}$, an internal circuitry determines the number of segments to be used to reduce current spikes.

## Step-Down Charge Pump Operation

When $\mathrm{V}_{\text {IN }} \geq 2.22 \times \mathrm{V}_{\text {OUT }}$, a $2: 1$ configuration shown in Fig.1(A) is enabled. The factor 0.9 is used instead of 1 in order to account for the effect of resistive losses across the switches and to accommodate hysteresis in the voltage detector comparator. Two phase non-overlapping clock signals are generated to drive four switches. When switches 1 and 3 are ON, switches 2 and 4 are OFF and $C_{B}$ is charged. When switches 2 and 4 are ON, switches 1 and 3 are OFF, charge is transferred from $\mathrm{C}_{\mathrm{B}}$ to $\mathrm{C}_{\text {OUT }}$.

When $\mathrm{V}_{\text {IN }}<2.22 \times \mathrm{V}_{\text {OUT }}$, a $1: 1$ configuration shown in Fig. 1(B) is enabled. In the 1:1 configuration switch 3 is always OFF and the switch 4 is always ON. At 1.6 V output setting the configuration changes from 2:1 to $1: 1$ at $\mathrm{V}_{\text {IN }}=$ 3.56 V . At 1.3 V output setting the change occurs at $\mathrm{V}_{\text {IN }}=$ 3.06 V

## Pulse-skipping PFM and Fractional Switch Operation

When the regulated output voltage reaches its upper limit, the switches are turned off the output voltage reaches its lower limit. Considering a step-down 2:1 mode of operation, 1.6 V output as an example, when the output reaches about 1.62 V (upper limit), the control logic turns off all switches. Switching stops completely. This is pulse-skipping mode. Since the supply is isolated from the output, the output voltage will drop. Once the output is dropped to about 1.58 V (lower limit), the device will return to regular switching mode with one quarter of each switch turning on first. Another quarter of each switch will be turned on if $\mathrm{V}_{\text {OUT }}$ cannot reach regulation by the time of arrival of the third

## Switch Configuration



Figure 1. (A)
2:1 configuration
Switches in charging phase
Reverse all switches for pumping phase
charge cycle. Full switch operation occurs only during startup or under heavy load condition, when half switch operation cannot achieve regulation within seven charge cycles.

## Soft Start

The soft-start feature limits inrush current when the device is initially powered up and enabled. The reference voltage is used to control the rate of the output voltage ramp-up to its final value. Typical start-up time is 1 ms . Since the rate of the output voltage ramp-up is controlled by an internally generated slow ramp, pulse-skipping occurs and inrush current is automatically limited.


Figure 1. (B)
1:1 configuration
Switch 3 is always off and
Switch 4 is always on
Switches 1 and 2 are in phase 1
Reverse the position of switches 1\&2
for phase 2

## Shutdown, UVLO, Short Circuit Current Limit and Thermal Shutdown

The device has an active-low shutdown pin to decrease supply current to less than $1 \mu \mathrm{~A}$. In shutdown mode the supply is disconnected from the output. UVLO triggers when supply voltage drops below 2 V . When the output voltage is lower than 150 mV , a short circuit protection is triggered. In this mode 15 out of 16 pulses during the switching will be skipped and the supply current is limited. Thermal shutdown triggers at $150^{\circ} \mathrm{C}$.

## Applications Information

Proper operation of the FAN5601 requires one ceramic bucket capacitor in the $0.1 \mu \mathrm{~F}$ to $1 \mu \mathrm{~F}$ range; one $10 \mu \mathrm{~F}$ output bypass capacitor and one $10 \mu \mathrm{~F}$ input bypass capacitor. In order to obtain optimum output ripple and noise performance, use of low ESR ( $<0.05 \Omega$ ) ceramic input and output bypass capacitors is recommended. The X5R and X7R rated capacitors provide adequate performance over the $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ temperature range.

The value of the bucket capacitor is dependent on load current requirements. A $1 \mu \mathrm{~F}$ bucket capacitor will work well in all applications at all load currents, while a $0.1 \mu \mathrm{~F}$ capacitor will support most applications under 100 mA of load current. The choice of bucket capacitor values should be verified in the actual application at the lowest input voltage and highest load current. A $30 \%$ margin of safety is recommended in order to account for the tolerance of the bucket capacitor and the variations in the on-resistance of the internal switches.

One of the key benefits of the ScalarPump ${ }^{\text {TM }}$ architecture is that the dynamically scaled on-resistance of the switches effectively reduces the peak current in the bucket capacitor and therefore input and output ripple current is also reduced. Nevertheless, due to the ESR of the input and output bypass capacitors, these current spikes generate voltage spikes at the input and output pins. However, these ESR spikes can be easily filtered because their frequency lie at up to 12 times the clock frequency.

In applications where conductive and radiated EMI/RFI interference has to be kept as low as possible, the user may consider the use of additional input and output filtering. For example, adding an L-C filter to the standard output bypass configuration is very effective in reducing both the output ripple and the voltage spikes. Figure 2 shows an L-C filter using a 100 nH chip inductor and a $1 \mu \mathrm{~F}$ capacitor. The channel 1 of Figure 3 shows the ripple voltage at the output of the device while Channel 2 shows the ripple voltage at the output of the filter at $\mathrm{V}_{\mathrm{IN}}=3.3 \mathrm{~V}$,


Figure 2. Optional L-C Filter
$\mathrm{V}_{\text {OUT }}=1.3 \mathrm{~V}$ and $\mathrm{I}_{\text {OUT }}=100 \mathrm{~mA}$. Similar filtering method will greatly reduce the current spikes at the input. The user should be mindful of considering resistive voltage drops in the inductors connected serially in the input and output leads.


Figure 3. Effect of L-C Filter on output ripple
While evaluating the FAN5601 (or any other switched capacitor DC-DC converter) the user should be careful to keep the power supply source impedance low; use of long wires causing high lead inductances and resistive losses should be avoided. A carefully laid out ground plane is essential because current spikes are generated as the bucket capacitor is charged and discharged. The input and output bypass capacitors should be placed as close to the device pins as possible.

## Mechanical Dimensions

## 6-Lead 3x3mm MLP Package



TOP VIEW

BOTTOM VIEW

NOTES:
A. CONFORMS TO JEDEC REGISTRATION MO-229, VARIATION WEEA, DATED 11/2001
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

## Ordering Information

| Product Number | Package Type | Voltage Option [Vnom] | Order Code |
| :---: | :---: | :---: | :---: |
| FAN5601 | 6 -Lead 3x3mm MLP | 1.3 V | FAN5601MP13X |
|  | 6 -Lead 3x3mm MLP | 1.8 V | FAN5601MP18X |

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